

# 1.5A, 50V - 1000V High Efficient Surface Mount Rectifier

### FEATURES

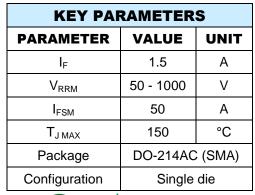
- AEC-Q101 qualified
- Glass passivated chip junction
- Ideal for automated placement
- Low profile package
- Fast switching for high efficiency
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

### **APPLICATIONS**

- DC to DC converter
- Automotive application
- Car lighting
- Snubber
- Freewheeling application

### **MECHANICAL DATA**

- Case: DO-214AC (SMA)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.060g (approximately)







DO-214AC (SMA)



ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)										
PARAMETER	SYMBOL	HS 2AA	HS 2BA	HS 2DA	HS 2FA	HS 2GA	HS 2JA	HS 2KA	HS 2MA	UNIT
		н	н	н	н	н	н	н	н	
Marking code on the device		HS 2AA	HS 2BA	HS 2DA	HS 2FA	HS 2GA	HS 2JA	HS 2KA	HS 2MA	
Repetitive peak reverse voltage	V <sub>RRM</sub>	50	100	200	300	400	600	800	1000	V
Reverse voltage, total rms value	V <sub>R(RMS)</sub>	35	70	140	210	280	420	560	700	V
Forward current	I <sub>F</sub>	1.5				А				
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	50				A				
Junction temperature	TJ	T <sub>J</sub> - 55 to +150			°C					
Storage temperature	T <sub>STG</sub>	- 55 to +150			°C					



Taiwan Semiconductor

THERMAL PERFORMANCE				
PARAMETER	SYMBOL	ТҮР	UNIT	
Junction-to-ambient thermal resistance	R <sub>eja</sub>	80	°C/W	

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)						
PARAMETER		CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
Forward voltage <sup>(1)</sup>	HS2AAH HS2BAH HS2DAH HS2FAH			-	1.0	V
	HS2GAH	I <sub>F</sub> = 1.5A, T <sub>J</sub> = 25°C	V <sub>F</sub>	-	1.3	V
	HS2JAH HS2KAH HS2MAH			-	1.7	V
	2)	$T_J = 25^{\circ}C$		-	5	μA
Reverse current @ rated $V_R^{(2)}$		T <sub>J</sub> = 125°C	I <sub>R</sub>	-	100	μA
Junction capacitance	HS2AAH HS2BAH HS2DAH HS2FAH HS2GAH	1MHz, V <sub>R</sub> = 4.0V	CJ	50	-	pF
	HS2JAH HS2KAH HS2MAH			30	-	pF
Reverse recovery time	HS2AAH HS2BAH HS2DAH HS2FAH HS2GAH	I <sub>F</sub> = 0.5A, I <sub>R</sub> = 1.0A, I <sub>rr</sub> = 0.25A	t <sub>rr</sub>	-	50	ns
	HS2JAH HS2KAH HS2MAH			-	75	ns

#### Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION				
ORDERING CODE <sup>(1)</sup>	PACKAGE	PACKING		
HS2xAH	DO-214AC (SMA)	7,500 / Tape & Reel		

#### Notes:

1. "x" defines voltage from 50V(HS2AAH) to 1000V(HS2MAH)



1000

100

10

1

10 20 30

INSTANTANEOUS REVERSE CURRENT (µA)

### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

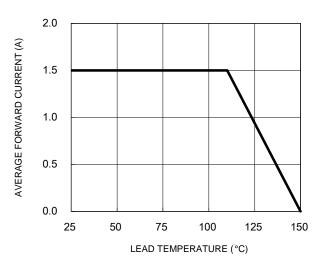


Fig.1 Forward Current Derating Curve

Fig.3 Typical Reverse Characteristics

T<sub>J</sub>=125°C

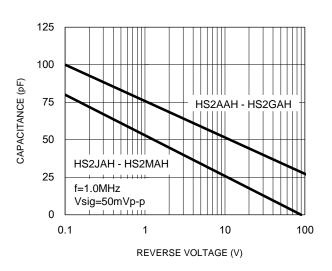
T\_=25°C

PERCENT OF RATED PEAK REVERSE VOLTAGE (%)

60 70 80

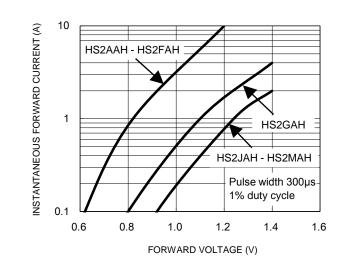
50

40



**Fig.2 Typical Junction Capacitance** 

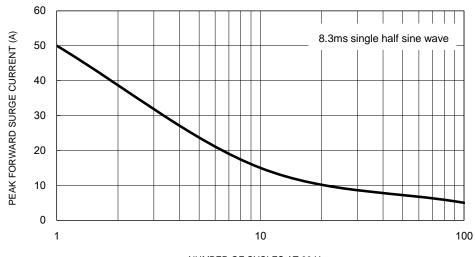
**Fig.4 Typical Forward Characteristics** 



#### Fig.5 Maximum Non-Repetitive Forward Surge Current

100

90

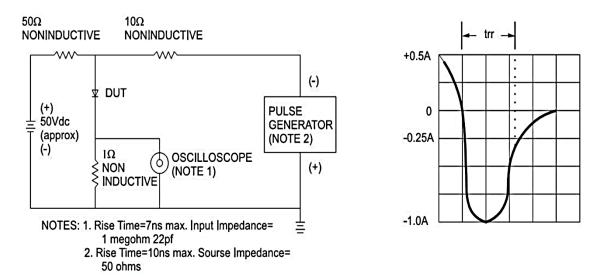


3



### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 



#### Fig.6 Reverse Recovery Time Characteristic and Test Circuit Diagram

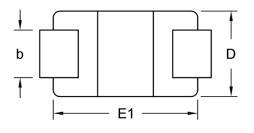


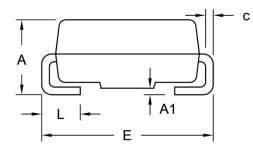


TAIWAN SEMICONDUCTOR

<del>Б</del>

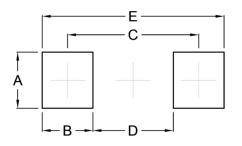
### DO-214AC (SMA)





DIM.	Unit	(mm)	Unit (inch)		
	Min.	Max.	Min.	Max.	
A	1.99	2.50	0.078	0.098	
A1	0.10	0.20	0.004	0.008	
b	1.27	1.58	0.050	0.062	
с	0.15	0.31	0.006	0.012	
D	2.29	2.83	0.090	0.111	
E	4.95	5.33	0.195	0.210	
E1	4.06	4.60	0.160	0.181	
L	0.90	1.41	0.035	0.056	

### SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	1.68	0.066
В	1.52	0.060
С	3.93	0.155
D	2.41	0.095
E	5.45	0.215

### **MARKING DIAGRAM**



P/N	= Marking Code
G	= Green Compound
YW	= Date Code

= Factory Code F



Taiwan Semiconductor

## Notice

Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Purchasers are solely responsible for the choice, selection, and use of TSC products and TSC assumes no liability for application assistance or the design of Purchasers' products.

Information contained herein is intended to provide a product description only. No license, express or implied, to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.